QSFP-100G-ZR4L

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100GBASE ZR4L QSFP28 Transceiver, LC, SMF, 60km, ≤5.5W, DOM



Features

- Compliant to Ethernet 100GBASE-60km
- Supports 103.125Gb/s aggregate bit rate
- Transmitter: cooled 4x25Gb/s LAN WDM EML TOSA (1295.56, 1300.05, 1304.58, 1309.14nm)
- Receiver: 4x25Gb/s APD ROSA
- Up to 60km reach for G.652 SMF
- Duplex LC optical receptacle
- 4x25G electrical interface (OIF CEI-28G-VSR)
- RoHS-10 compliant and lead-free
- Single +3.3V power supply
- Maximum power consumption ≤5.5W
- Case operating temperature
 - Commercial: 0 ~ +70oC
 - Extended: -10 ~ +80oC
 - Industrial: -40 ~ +85oC

Applications

- 100GBASE-60km Ethernet Links
- Infiniband QDR and DDR interconnects
- Client-side 100G Telecom connections

General Description

This product is a 100Gb/s transceiver module designed for optical communication applications, compliant to Ethernet 100GBASE-60km standard. The module converts 4 input channels of 25Gb/s electrical data to 4 channels of LAN WDM optical signals and then multiplexes them into a single channel for 100Gb/s optical transmission. Reversely on the receiver side, the module de-multiplexes a 100Gb/s optical input into 4 channels of LAN WDM optical signals and then converts them to 4 output channels of electrical data.

The central wavelengths of the 4 LAN WDM channels are 1295.56, 1300.05, 1304.58 and 1309.14nm as members of the LAN WDM wavelength grid defined in IEEE 802.3ba. The high- performance cooled LAN WDM EA-DFB transmitters and high sensitivity APD receivers provide superior performance for 100Gigabit Ethernet applications up to 60km links.



The product is designed with form factor, optical/electrical connection and digital diagnostic interface according to the QSFP+ Multi-Source Agreement (MSA). It has been designed to meet the harshest external operating conditions including temperature, humidity and EMI interference.

Functional Description

The transceiver module receives 4 channels of 25Gb/s electrical data, which are processed by a 4-channel Clock and Data Recovery (CDR) IC that reshapes and reduces the jitter of each electrical signal. Subsequently, EML laser driver IC converts each one of the 4 channels of electrical signals to an optical signal that is transmitted from one of the 4 cooled EML lasers which are packaged in the Transmitter Optical Sub-Assembly (TOSA). These 4-lane optical signals will be optically multiplexed into a single fiber by a 4-to-1 optical WDM MUX. The optical output power of each channel is maintained constant by an automatic power control (APC) circuit. The transmitter output can be turned off by TX_DIS hardware signal and/or 2-wire serial interface.

The receiver receives 4-lane LAN WDM optical signals. The optical signals are de-multiplexed by a 1-to-4 optical DEMUX and each of the resulting 4 channels of optical signals is fed into one of the 4 receivers that are packaged into the Receiver Optical Sub-Assembly (ROSA). Each receiver converts the optical signal to an electrical signal. The regenerated electrical signals are retimed and de-jittered and amplified by the RX portion of the 4-channel CDR. The retimed 4-lane output electrical signals are compliant with CEI-28G-VSR interface requirements. In addition, each received optical signal is monitored by the DOM section. The monitored value is reported through the 2-wire serial interface. If one or more received optical signal is weaker than the threshold level, RX_LOS hardware alarm will be triggered.

A single +3.3V power supply is required to power up this product. Both power supply pins VccTx and VccRx are internally connected and should be applied concurrently. As per MSA specifications the module offers 7 low speed hardware control pins (including the 2-wire serial interface): ModSelL, SCL, SDA, ResetL, LPMode, ModPrsL and IntL.

Module Select (ModSelL) is an input pin. When held low by the host, this product responds to 2-wire serial communication commands. The ModSelL allows the use of this product on a single 2-wire interface bus – individual ModSelL lines must be used.

Serial Clock (SCL) and Serial Data (SDA) are required for the 2-wire serial bus communication interface and enable the host to access the QSFP28 memory map.

The ResetL pin enables a complete reset, returning the settings to their default state, when a low level on the ResetL pin is held for longer than the minimum pulse length. During the execution of a reset the host shall disregard all status bits until it indicates a completion of the reset interrupt. The product indicates this by posting an IntL (Interrupt) signal with the Data_Not_Ready bit negated in the memory map. Note that on power up (including hot insertion) the module should post this completion of reset interrupt without requiring a reset.

Low Power Mode (LPMode) pin is used to set the maximum power consumption for the product in order to protect hosts that are not capable of cooling higher power modules, should such modules be accidentally inserted.



Module Present (ModPrsL) is a signal local to the host board which, in the absence of a product, is normally pulled up to the host Vcc. When the product is inserted into the connector, it completes the path to ground through a resistor on the host board and asserts the signal. ModPrsL then indicates its present by setting ModPrsL to a "Low" state.

Interrupt (IntL) is an output pin. "Low" indicates a possible operational fault or a status critical to the host system. The host identifies the source of the interrupt using the 2-wire serial interface. The IntL pin is an open collector output and must be pulled to the Host Vcc voltage on the Host board.

Absolute Maximum Ratings

It has to be noted that the operation in excess of any individual absolute maximum ratings might cause permanent damage to this module.

Parameter	Symbol	Min	Max	Unit	Notes
Storage Temperature	TS	-40	85	оС	
Power Supply Voltage	VCC	-0.3	4.0	V	
Relative Humidity (non-condensation)	RH	0	85	%	

Recommended Operating Conditions

Parameter	Symbol	Min	Typical	Max	Unit	Notes
		0		70		commercial
		-10		80	oC	extended
Operating Case Temperature	TOP	-40		85		Industrial
Power Supply Voltage	VCC	3.135	3.3	3.465	V	
Data Rate, each Lane			25.78125		Gb/s	
Control Input Voltage High		2		Vcc	V	
Control Input Voltage Low		0		0.8	V	
Link Distance (SMF)	D			60	km	1

Notes:

1. Depending on actual fiber loss/km (link distance specified is for fiber insertion loss of 0.35dB/km)



Pin Assignment and Pin Description

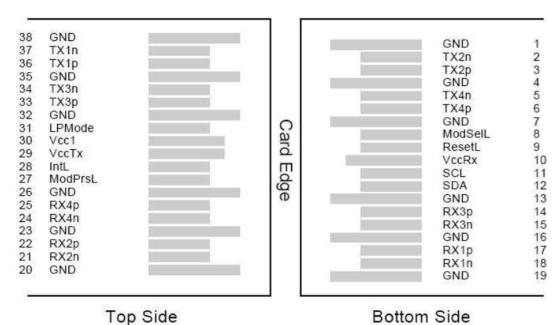


Figure 1. Diagram of host board connector block pin numbers andnames

Pin	Symbol	Name/Description	Notes
1	GND	Transmitter Ground (Common with Receiver Ground)	1
2	Tx2n	Transmitter Inverted Data Input	
3	Тх2р	Transmitter Non-Inverted Data output	
4	GND	Transmitter Ground (Common with Receiver Ground)	1
5	Tx4n	Transmitter Inverted Data Input	
6	Тх4р	Transmitter Non-Inverted Data output	
7	GND	Transmitter Ground (Common with Receiver Ground)	1
8	ModSelL	Module Select	
9	ResetL	Module Reset	
10	VccRx	3.3V Power Supply Receiver	2
11	SCL	2-Wire serial Interface Clock	
12	SDA	2-Wire serial Interface Data	
13	GND	Transmitter Ground (Common with Receiver Ground)	
14	Rx3p	Receiver Non-Inverted Data Output	
15	Rx3n	Receiver Inverted Data Output	



GND	T ::: 0 1/0 ::1 D : 0 1/	
GIND	Transmitter Ground (Common with Receiver Ground)	1
Rx1p	Receiver Non-Inverted Data Output	
Rx1n	Receiver Inverted Data Output	
GND	Transmitter Ground (Common with Receiver Ground)	1
GND	Transmitter Ground (Common with Receiver Ground)	1
Rx2n	Receiver Inverted Data Output	
Rx2p	Receiver Non-Inverted Data Output	
GND	Transmitter Ground (Common with Receiver Ground)	1
Rx4n	Receiver Inverted Data Output	1
Rx4p	Receiver Non-Inverted Data Output	
GND	Transmitter Ground (Common with Receiver Ground)	1
ModPrsl	Module Present	
IntL	Interrupt	
VccTx	3.3V power supply transmitter	2
Vcc1	3.3V power supply	2
LPMode	Low Power Mode	
GND	Transmitter Ground (Common with Receiver Ground)	1
Тх3р	Transmitter Non-Inverted Data Input	
Tx3n	Transmitter Inverted Data Output	
GND	Transmitter Ground (Common with Receiver Ground)	1
Тх1р	Transmitter Non-Inverted Data Input	
Tx1n	Transmitter Inverted Data Output	
GND	Transmitter Ground (Common with Receiver Ground)	1
	Rx1n GND GND Rx2n Rx2p GND Rx4n Rx4p GND ModPrsl IntL VccTx Vcc1 LPMode GND Tx3p Tx3n GND Tx1p Tx1n	Rx1n Receiver Inverted Data Output GND Transmitter Ground (Common with Receiver Ground) GND Transmitter Ground (Common with Receiver Ground) Rx2n Receiver Inverted Data Output Rx2p Receiver Non-Inverted Data Output GND Transmitter Ground (Common with Receiver Ground) Rx4n Receiver Inverted Data Output Rx4p Receiver Non-Inverted Data Output GND Transmitter Ground (Common with Receiver Ground) ModPrsl Module Present IntL Interrupt VccTx 3.3V power supply transmitter Vcc1 3.3V power supply LPMode Low Power Mode GND Transmitter Ground (Common with Receiver Ground) Tx3p Transmitter Non-Inverted Data Input Tx3n Transmitter Inverted Data Output GND Transmitter Ground (Common with Receiver Ground) Tx1p Transmitter Non-Inverted Data Input Tx1n Transmitter Inverted Data Output

Notes:

- 1. GND is the symbol for signal and supply (power) common for QSFP28 modules. All are common within the QSFP28 module and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal common ground plane.
- 2. VccRx, Vcc1 and VccTx are the receiving and transmission power suppliers and shall be applied concurrently. Recommended host board power supply filtering is shown below. Vcc Rx, Vcc1 and Vcc Tx may be internally connected within the QSFP28 transceiver module in any combination. The connector pins are each rated for a maximum current of 1000mA.



Electrical Characteristics

The following electrical characteristics are defined over the Recommended Operating Environment unless otherwise specified.

Parameter	Symbol	Min	Тур.	Max	Unit	Note
Power Consumption	р			5	W	
Supply Current	Icc			1440	mA	
Tra	nsmitter (each La	ane)				
Input differential impedance	Rin		100		Ω	
Differential Termination Mismatch				10	%	
Differential Data Input Amplitude	Vin, PP	180		1000	mV	
LPMode, Reset and ModSelL	VIL	-0.3		0.8	V	
	VIH	2		Vcc+0.3	V	
	Receiver					
Differential Data Output Amplitude	Vout, PP	350		900	mV	
Differential Termination Mismatch				10	%	
Transition Time, 20 to 80%		9.5			ps	
ModPrsL and IntL	VOL	0		0.4	V	
	VOH	Vcc-0.5		Vcc+0.3	V	

Optical Parameters

The following optical characteristics are defined over the Recommended Operating Environment unless otherwise specified.

Parameter	Symbol	Min	Typical	Max	Unit	Notes			
Transmitter									
	LO	1294.53	1295.56	1296.59	nm				
	L1	1299.02	1300.05	1301.09	nm				
Lane wavelength (range)	L2	1303.54	1304.58	1305.63	nm				
	L3	1308.09	1309.14	1310.09	nm				
Signaling rate, each lane			25.78125		GBd				
Side-mode suppression ratio	SMSR	30							
Total launch power	РТ			10.5	dBm				



Average launch power, each lane	Pavg	1.0		4.5	dBm	
OMA, each Lane	POMA	1.5		5.3	dBm	
Extinction Ratio	ER	6.0			dB	
Difference in Launch Power between any Two Lanes (OMA)	Ptx,diff			3.6	dB	
Transmitter and Dispersion Penalty, each lane	TDP			2.5	dB	
OMA minus TDP, each lane	OMA-TDP	-0.65			dBm	
Average launch power of OFF transmitter, each lane	Poff			-30	dBm	
Transmitter reflectance	RT			-12	dB	
RIN200MA	RIN			-130	dB/Hz	
Optical Return Loss Tolerance	TOL			20	dB	
Transmitter eye mask {X1, X2, X3, Y1, Y2, Y3}		{0.25, 0.4, 0.45, 0.25, 0.28, 0.4}				
	Rec	eiver				
Signaling rate, each lane			25.78125		GBd	
Average Receive Power, each Lane		-22		-4.5	dBm	
Receive Power (OMA), each Lane				-1.9	dBm	
Receiver Sensitivity, Average, each Lane	SEN1			-19.5	dBm	1
Receiver reflectance				-26	dB	
Difference in Receive Power between any Two Lanes (Average and OMA)	Ptx,diff			3.6	dB	
LOS Assert	LOSA	-35			dBm	
LOS Deassert	LOSD			-22	dBm	
LOS Hysteresis	LOSH	0.5			dB	

Notes:

1. Measured with a PRBS 2³¹ -1 test pattern, @25.78Gb/s, BER<1E-12.



Digital Diagnostic Functions

The following digital diagnostic characteristics are defined over the normal operating conditions unless otherwise specified.

Parameter	Symbol	Min.	Max	Unit	Range
Temperature monitor absolute error	DMI_ Temp	-3	3	оС	-40~85C
Supply voltage monitor absolute error	DMI_VCC	-3	3	%	0~Vcc
RX power monitor absolute error	DMI_RX	-3	3	dB	-5~-26dBm
Bias current monitor error	DMI_ bias	-10	10	%	0~100mA
TX power monitor absolute error	DMI_TX	-3	3	dB	-2.9~4.5dBm

Mechanical Dimensions

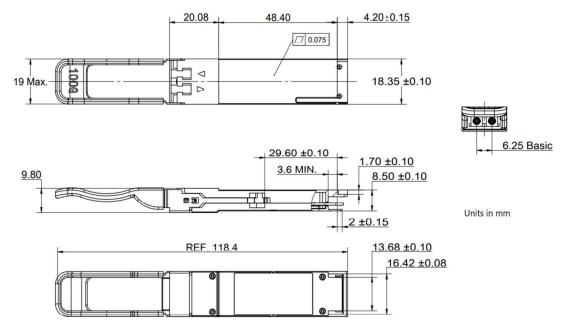


Figure 2. Mechanical Outline